

# **Final Product Change Notification**

Issue Date: 25-Mar-2020 Effective Date: 23-Jun-2020

Dear Emma Tempest,

Here's your personalized quality information concerning products Premier Farnell PLC purchased from NXP.

For detailed information we invite you to <u>view this</u> notification online

This notice is NXP Company Proprietary.

# 202003002F01



# **Change Category**

[] Wafer Fab Process	[] Assembly Process	[] Product Marking	[] Test Location	[] Design
[] Wafer Fab Materials	[] Assembly Materials	[] Mechanical Specification	[]Test Process	[] Errata
[]Wafer Fab Location []Firmware	[X] Assembly Location [] Other	[] Packing/Shipping/Labeling		[] Electrical spec./Test coverage

i.MX 8M Mini Assembly Site Expansion from ATK4 to ASEKH

# **Description of Change**

NXP Semiconductors announces the Assembly site expansion for i.MX 8M Mini associated with this notification, from the current Amkor ATK4, Kwangju, Korea assembly facility to the ASE-KH, Kaohsiung, Taiwan assembly facility.

Assembly site expansion was successfully qualified adhering to NXP specifications.

Please see the attached file(s) for additional details.

# Reason for Change

Qualification of the ASE-KH, Kaohsiung, Taiwan is required for manufacturing flexibility and customer supply assurance.

# **Identification of Affected Products**

Top side marking

The assembly site, among other information, is reflected in the package trace code.

The format for NXP standard trace code is AWLYYWWZ:

A=Assembly Site, WL=Wafer Lot, YY=Year, WW=Work Week, Z=The Assembly Lot Split code.

Assembly site marking for ATK4 is A = 'SB'.

Assembly site marking for ASEKH is A = 'ZK'.

# **Sample Information**

Samples are available upon request

PIMX8MM6DVTLZAA

#### **Production**

Planned first shipment 07-Jul-2020

# Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

#### **Disposition of Old Products**

NXP will reserve the right to ship from both locations based on market demand situation.

# **Additional information**

Affected products and sales history information: see attached file

Self qualification: <u>view online</u>
Additional documents: <u>view online</u>

# **Timing and Logistics**

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by 24-Apr-2020.

# **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please <u>contact NXP "Global Quality Support Team"</u>.

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Amanda Mcgregor

Position Product Marketing Manager e-mail address amanda.mcgregor@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they

reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

#### NXP Quality Management Team.

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